

Global IC Chip Packaging and Testing Market 2025 by Manufacturers, Regions, Type and Application, Forecast to 2031

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Abstracts

According to our (Global Info Research) latest study, the global IC Chip Packaging and Testing market size was valued at US\$ 486 million in 2024 and is forecast to a readjusted size of USD 854 million by 2031 with a CAGR of 8.5% during review period.

IC chip packages refer to materials that contain semiconductor devices. Encapsulation is an enclosure that surrounds circuit material to protect it from corrosion or physical damage and to allow mounting of electrical contacts that connect it to a printed circuit board (PCB). IC chip packaging is capable of providing more and more I/O interconnects to smaller and smaller dies (bare chips).

Following a strong growth of 26.2 percent in the year 2021, WSTS revised it down to a single digit growth for the worldwide semiconductor market in 2022 with a total size of US\$580 billion, up 4.4 percent. WSTS lowered growth estimation as inflation rises and end markets seeing weaker demand, especially those exposed to consumer spending. While some major categories are still double-digit year-over-year growth in 2022, led by Analog with 20.8 percent, Sensors with 16.3 percent, and Logic with 14.5 percent growth. Memory declined with 12.6 percent year over year. In 2022, all geographical regions showed double-digit growth except Asia Pacific. The largest region, Asia Pacific, declined 2.0 percent. Sales in the Americas were US\$142.1 billion, up 17.0% year-on-year, sales in Europe were US\$53.8 billion, up 12.6% year-on-year, and sales in Japan were US\$48.1 billion, up 10.0% year-on-year. However, sales in the largest Asia-Pacific region were US\$336.2 billion, down 2.0% year-on-year.

This report is a detailed and comprehensive analysis for global IC Chip Packaging and Testing market. Both quantitative and qualitative analyses are presented by



manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global IC Chip Packaging and Testing market size and forecasts, in consumption value (\$ Million), sales quantity (K Units), and average selling prices (US\$/Unit), 2020-2031

Global IC Chip Packaging and Testing market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (K Units), and average selling prices (US\$/Unit), 2020-2031

Global IC Chip Packaging and Testing market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (K Units), and average selling prices (US\$/Unit), 2020-2031

Global IC Chip Packaging and Testing market shares of main players, shipments in revenue (\$ Million), sales quantity (K Units), and ASP (US\$/Unit), 2020-2025

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for IC Chip Packaging and Testing

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global IC Chip Packaging and Testing market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include ASE, Amkor Technology, SPIL, Powertech Technology, UTAC, Chipbond Technology, Hana Micron, OSE, Walton Advanced Engineering, NEPES, etc.



This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

IC Chip Packaging and Testing market is split by Type and by Application. For the period 2020-2031, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.



Major players covered



ASE	
Amkor Technology	
SPIL	
Powertech Technology	
UTAC	
Chipbond Technology	
Hana Micron	
OSE	
Walton Advanced Engineering	
NEPES	
Unisem	
ChipMOS Technologies	
Signetics	
Carsem	
KYEC	
J-Devices	
ITEQ	
HT-Tech	
JCET	

TongFu Microelectronics



Chipmore Technology

China Resources Microelectronics

Forehope Electronic

Wafer Level CSP

Chizhou HISEMI Electronic Technology

Keyang

Leadyo IC Testing

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe IC Chip Packaging and Testing product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of IC Chip Packaging and Testing, with price, sales quantity, revenue, and global market share of IC Chip Packaging and Testing from 2020 to 2025.

Chapter 3, the IC Chip Packaging and Testing competitive situation, sales quantity,



revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the IC Chip Packaging and Testing breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2020 to 2031.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2020 to 2031.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2020 to 2025.and IC Chip Packaging and Testing market forecast, by regions, by Type, and by Application, with sales and revenue, from 2026 to 2031.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of IC Chip Packaging and Testing.

Chapter 14 and 15, to describe IC Chip Packaging and Testing sales channel, distributors, customers, research findings and conclusion.



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